Revealing thermal transport mechanism in thermoelectric materials

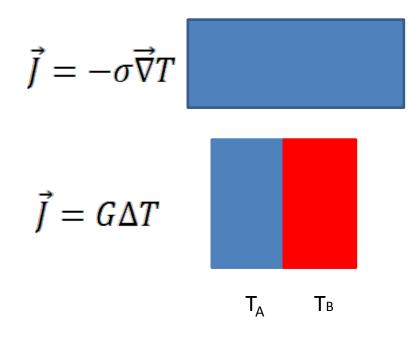
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Electron Micrscopy and Nanostructure Group

Thermal conductivity

Figure of merit: inversely proportional to thermal conductivity



- T: temperature
- σ: Bulk thermal conductivity unit: W/m·K

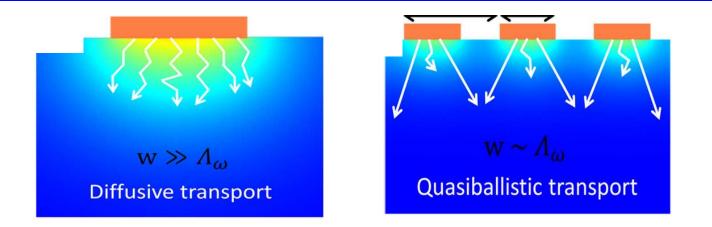
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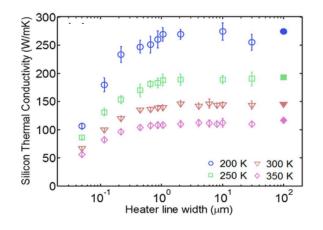
G: Interface thermal conductivity unit: W/m²K

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Phonon transport at short wavelength





Thermoelectric materials: MFP is too short

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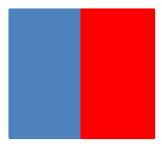
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Zeng, L., Scientific Reports 5, 17131 (2015)

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Interface heat transport

• Acoustic-mismatch (AM) model $t_{AB} = \frac{4Z_A Z_B}{(Z_A + Z_B)^2} \qquad Z = \rho c$



• diffuse mismatch (DM)model



the probability of being scattered to one side is simply proportional to the phonon density of states

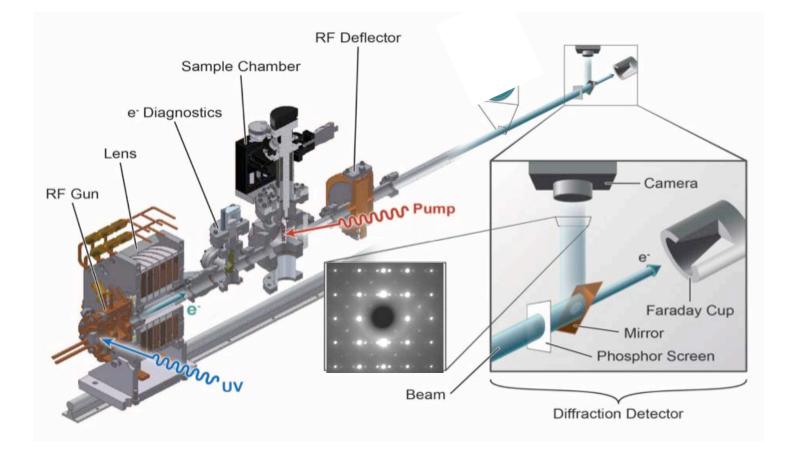
Nanometer scale materials: theory and regular measurement method don't work

Cahill, D. G., J. App. Phys. 93, 793 (2003)

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MeV-Ultrafast Electron Diffraction

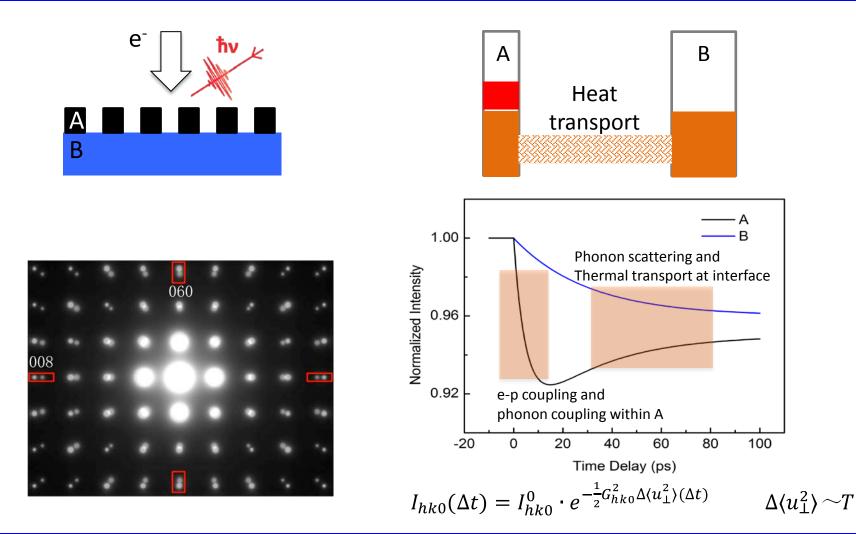


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Time resolved method with UED

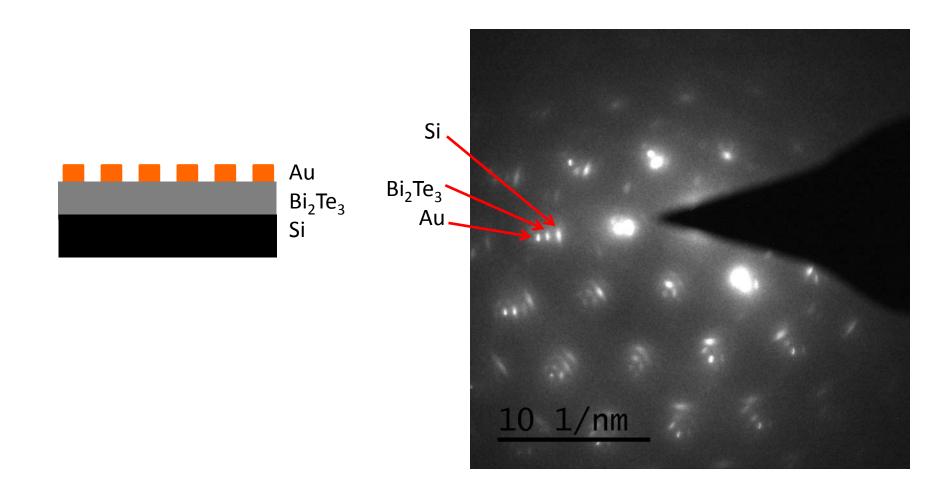


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Electron diffraction test on Au/Bi₂Te₃/Si



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Summary

- Difficult to measure heat transport at nanometer scale
- UED present a unique method to scale temperature and measure thermal conductivity.
- > Preliminary test shows promising result

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Thank You!

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